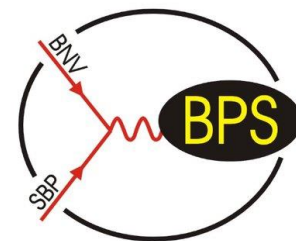


# Development of paper-based lab-on-chip devices based on molecularly imprinted polymers

By Frederik Vreys

Promotor: Ronald Thoelen

Co-promotor: Anitha Ethirajan



IMO-IMOMEC



imec

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# Introduction

Heat-transfer method for lab-on-chip applications

**Small reaction chamber**

faster analysis &  
response times

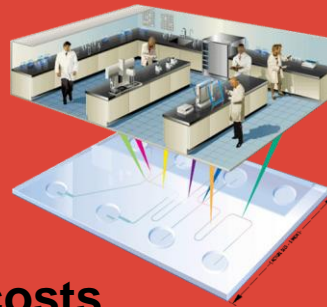
**low fluid volumes consumption**

safer platform

massive parallelization

**lower fabrication costs**

**cost-effective disposable chips**



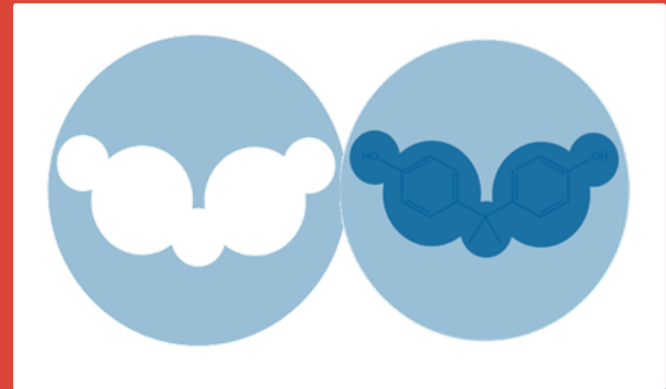
# Key ingredients

Heat-transfer method for lab-on-chip applications

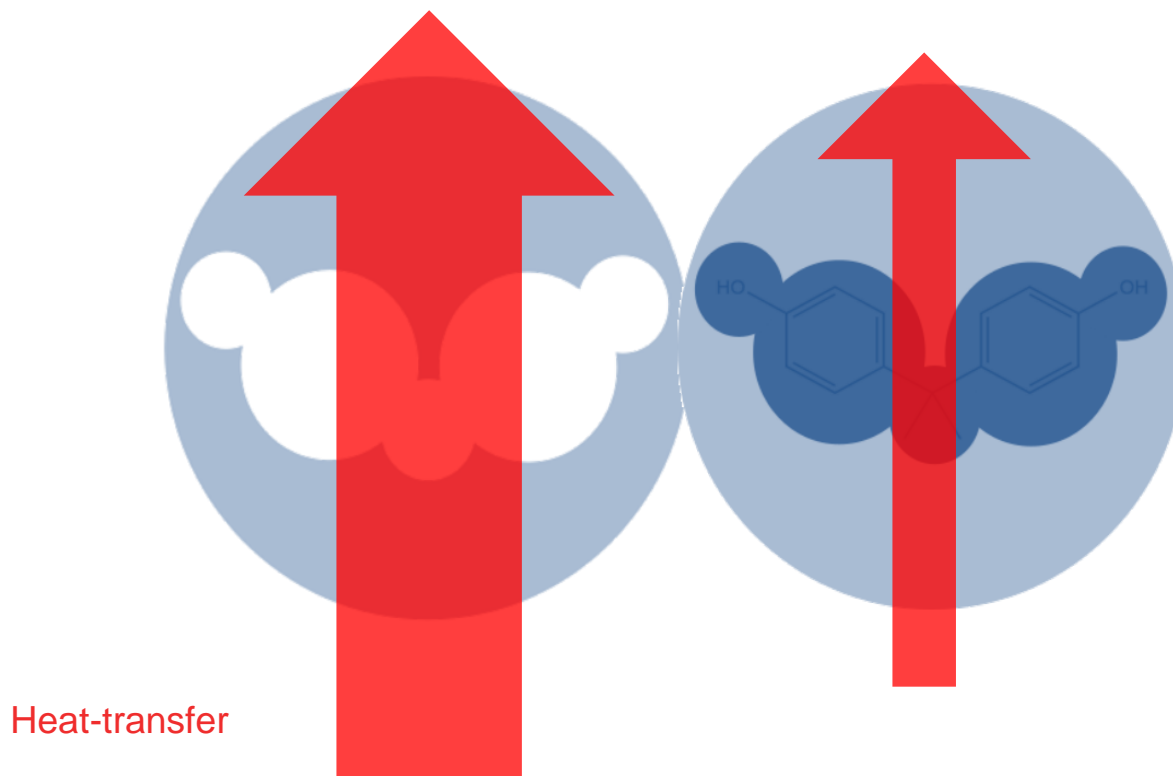
TRANSDUCER:  
THERMAL BASED



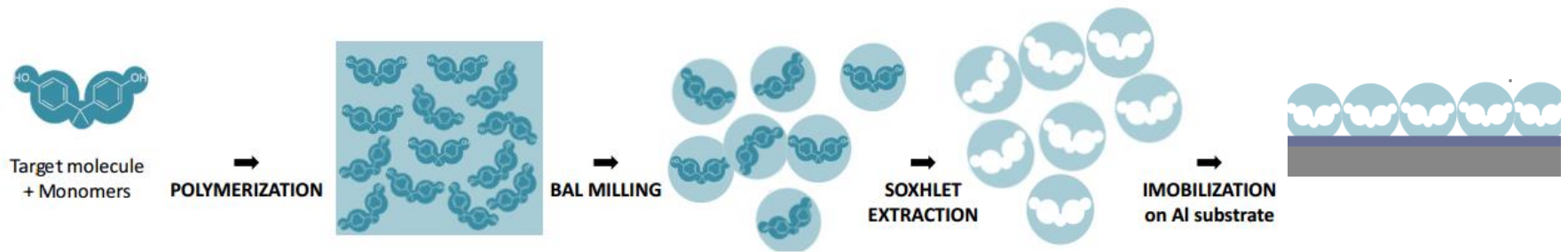
RECEPTOR:  
MOLECULARLY  
IMPRINTED POLYMERS



# PORE-BLOCKING MODEL



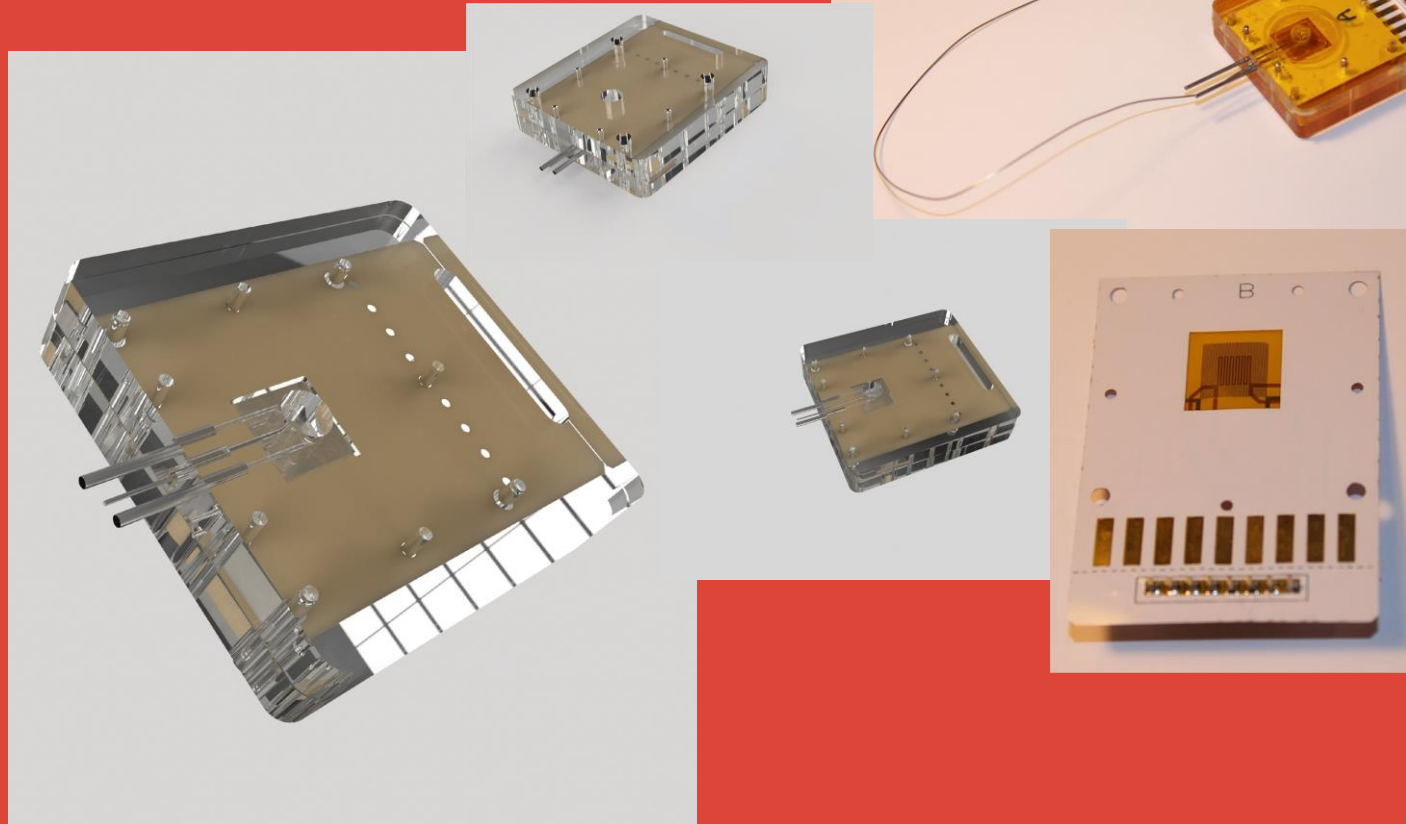
# SYNTHETIC RECEPTOR: MOLECULARLY IMPRINTED POLYMER (MIP)



Bulk MIP production process

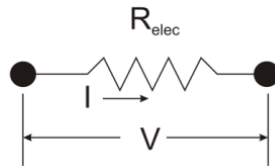
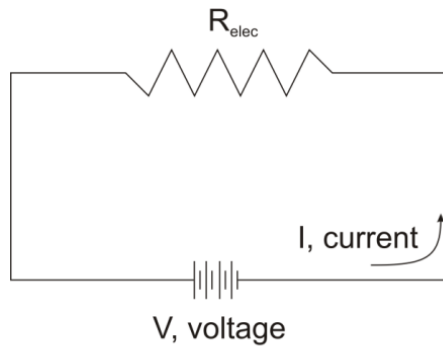
# TRANSDUCER

Heat-transfer method

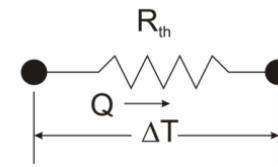
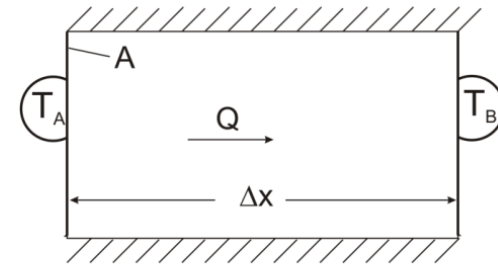


# PRINCIPLE: HEAT-TRANSFER RESISTANCE

## Electric resistance/impedance



## Heat-Transfer resistance



# PRINCIPLE: HEAT-TRANSFER RESISTANCE

## Electric resistance/impedance

Reason: voltage  $V$  [V]

Result: current  $I$  [A]

$$= \frac{\text{charge}}{\text{time}} \quad [A = \frac{1C}{s}]$$

Ohmic resistance:  $R = \frac{V}{I}$  [ $\Omega$ ]

## Heat-Transfer resistance

Reason: temperature difference  $T_A - T_B$

Result: thermal current  $P$  [W]

$$= \frac{\text{energy}}{\text{time}} = \text{power} \quad [W = \frac{1J}{s}]$$

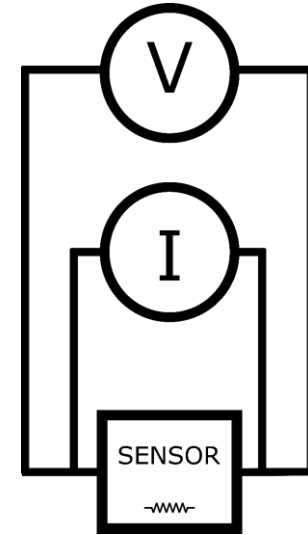
Thermal resistance:  $R_{th} = \frac{T_A - T_B}{P}$  [ $\frac{^\circ C}{W}$ ]




# READ-OUT: HEATING ELEMENT

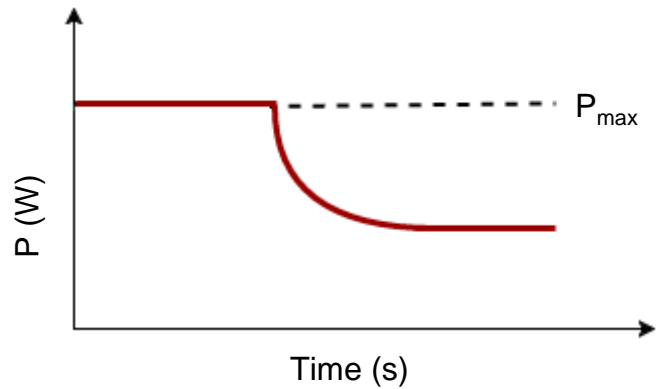
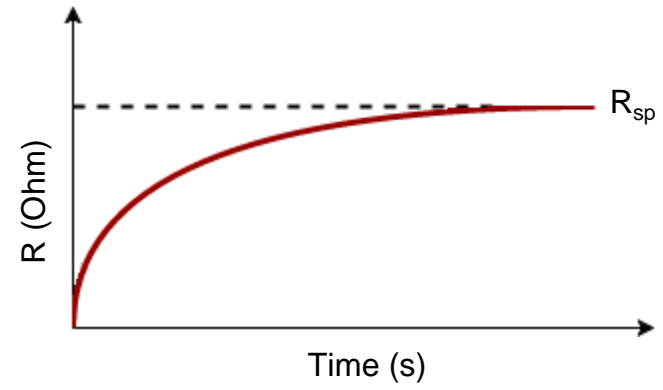
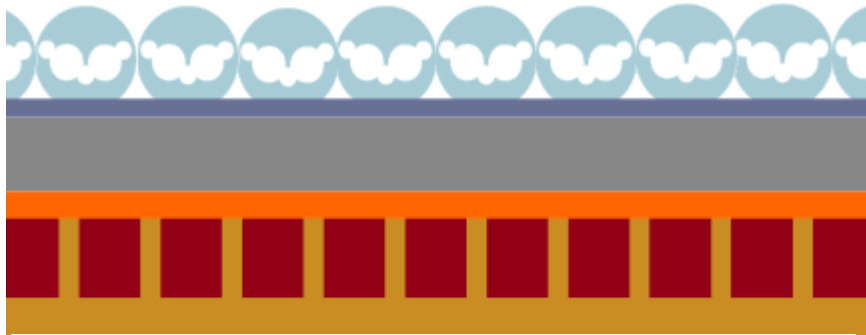
- 4-wire measurement
  - Source current
  - Measure voltage
- Temperature coefficient of resistance (TCR)

$$R = R_{ref} [1 + \alpha (T - T_{ref})] \quad [\Omega]$$

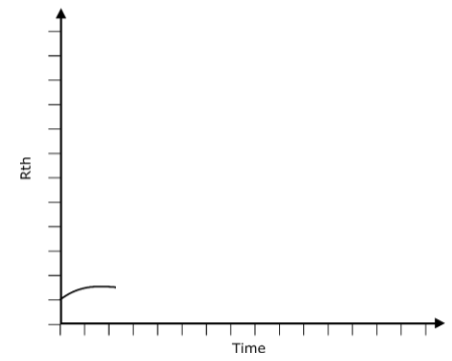


# READ-OUT: WORKING PRINCIPLE

Thermocouple 

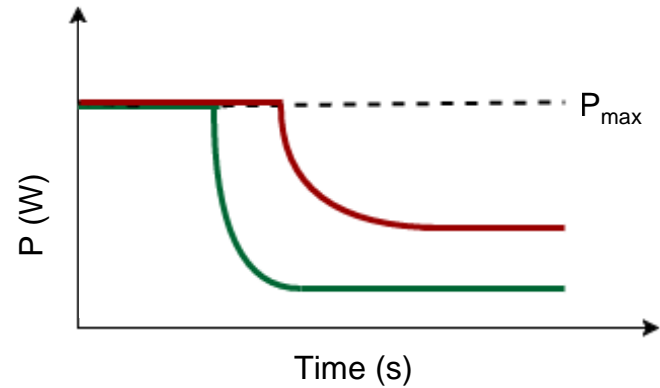
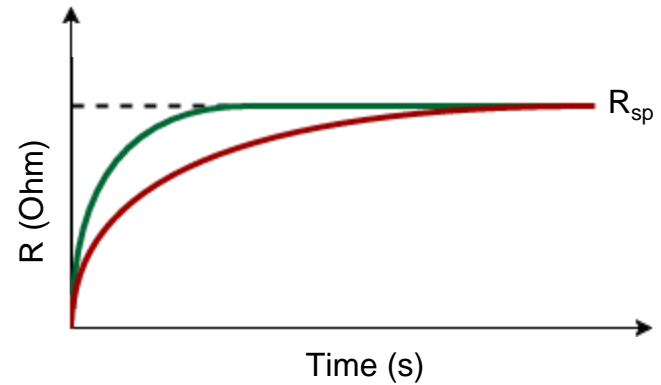
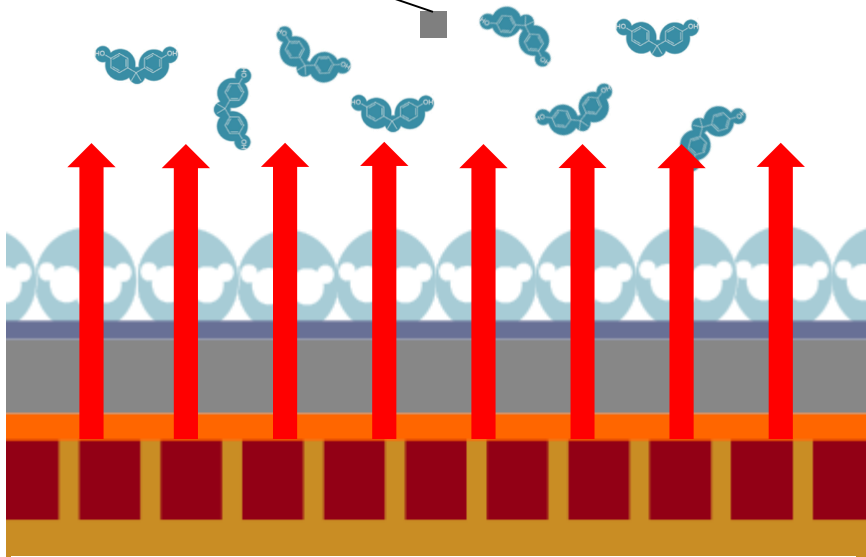


$$R_{th} = \frac{T_A - T_B}{P} \left[ \frac{^{\circ}C}{W} \right]$$

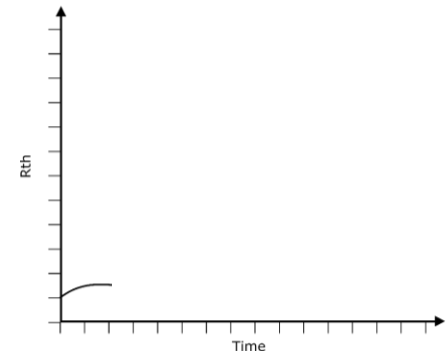


# READ-OUT: WORKING PRINCIPLE

Thermocouple

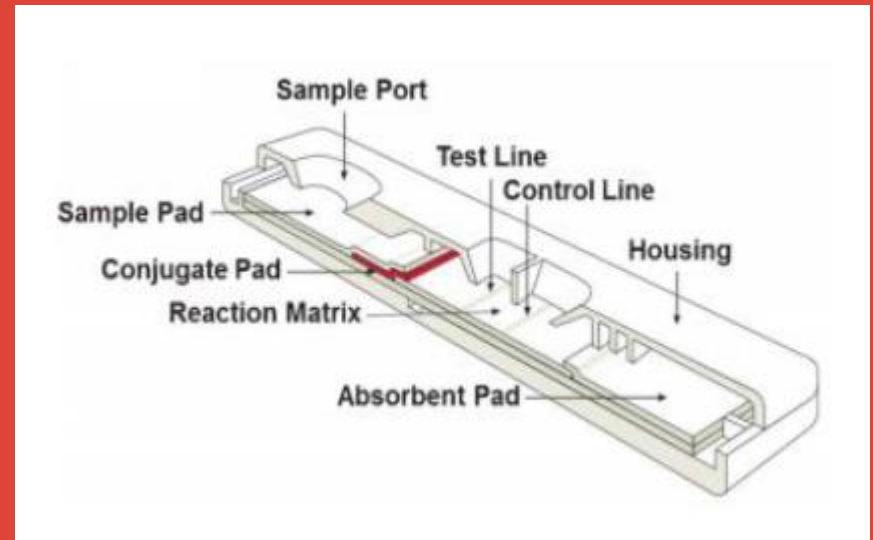


$$R_{th} = \frac{T_A - T_B}{P} \left[ \frac{^{\circ}C}{W} \right]$$



# POINT-OF-CARE

Paper-based microfluidics



# DESIGN & DEVELOPMENT

## Materials

Kapton tape as sealant and MIP adhesive

Low thermal resistance

Bisphenol-A MIPs

Whatman Nr 1. Filter paper

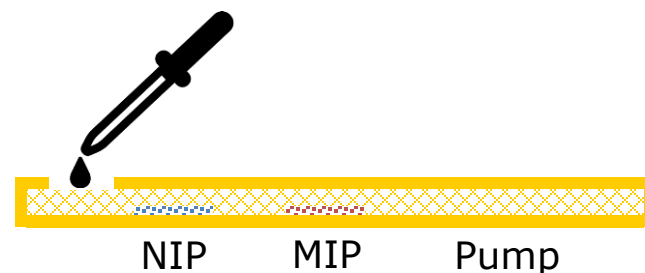
## Methods

Laser cut filter paper

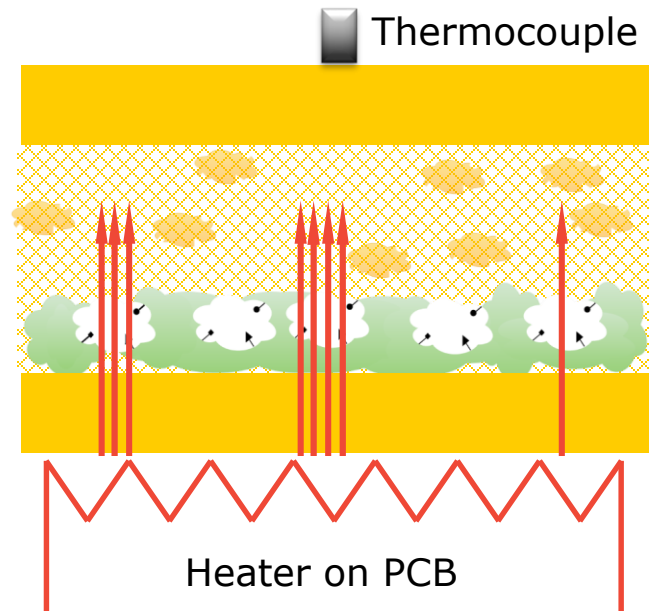
$\mu$ Pad contains pump/absorbent pad

20 $\mu$ L absorbing capacity

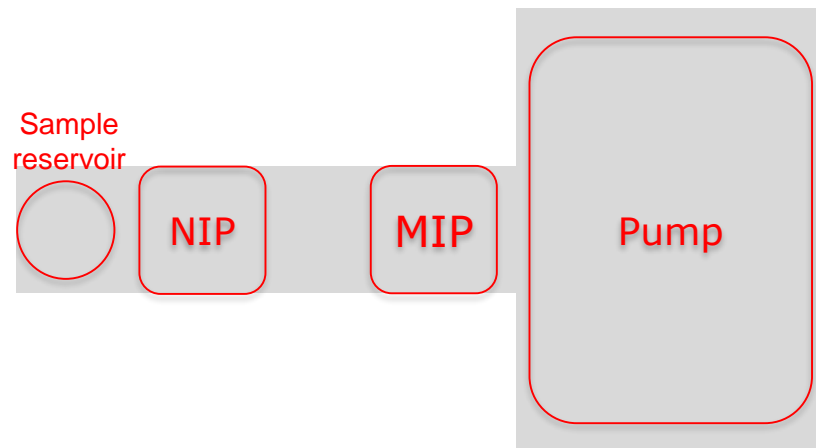
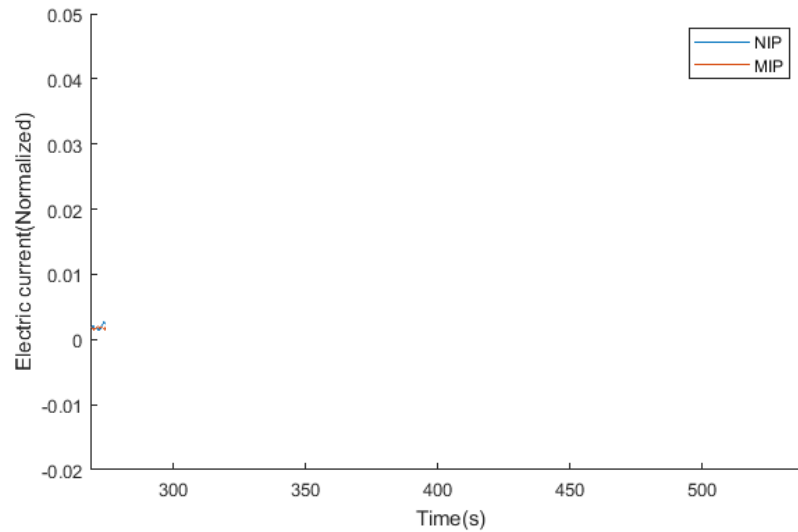
120 sec / measurement



# READ-OUT: WORKING PRINCIPLE



# PROOF-OF-PRINCIPLE: BISPHENOL-A



# CONCLUSIONS & OUTLOOK

- Fast, disposable
- Point-of-care
- Cross-referencing with impedance spectroscopy



**THANK YOU!**

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▶▶ UHASSELT **mec**